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Part Number: 0782793002

Status: Planned for Obsolescence

Description: 0.60mm (.024") Pitch DDR3 SODIMM Socket, Right Angle, Reverse Mount, 5.20mm

(.205") Mount Height, 204 Circuits, Lead Free

Documents:

<u>3D Model</u> <u>Product Specification PS-78279-001 (PDF)</u>
<u>Drawing (PDF)</u> <u>RoHS Certificate of Compliance (PDF)</u>

Agency Certification

CSA LR19980 UL E29179

General

Product Family Memory Module Sockets

Series 78279
Component Type Socket
JEDEC Outline N/A

Product Name DDR3 S.O. DIMM

Physical

204 Circuits (Loaded) Circuits (maximum) 204 Color - Resin Black Durability (mating cycles max) 25 **Entry Angle** 25° Angle Flammability 94V-0 Keying to Mating Part Yes Material - Plating Mating Gold Material - Plating Termination Gold

Material - Resin High Temperature Thermoplastic

PCB Locator Yes
PCB Retention Yes
Packaging Type Tray

 $\begin{array}{lll} \mbox{Pitch - Mating Interface} & 0.60\mbox{mm } (.024") \\ \mbox{Pitch - Termination Interface} & 0.60\mbox{mm } (.024") \\ \mbox{Plating min - Mating} & 0.762\mbox{µm } (30\mbox{µ"}) \\ \mbox{Plating min - Termination} & 0.762\mbox{µm } (30\mbox{µ"}) \\ \mbox{Temperature Range - Operating} & -55\mbox{°C to +85\mbox{°C}} \\ \mbox{Termination Interface: Style} & \mbox{Surface Mount} \end{array}$

Electrical

Current - Maximum per Contact 0.6A Voltage - Maximum 25V AC

Solder Process Data

Duration at Max. Process Temperature (seconds) 20

Lead-free Process Capability Reflow Capable (SMT only)

Max. Cycles at Max. Process Temperature 2
Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Product Specification PS-78279-001 Sales Drawing SD-78279-001



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